

### **Technical Data Sheet**

# 0603 Package chip LED (0.4mm Height)

#### 19-217/BHC-XL2M2TY/3T

#### **Features**

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-Free

#### **Descriptions**

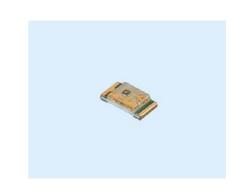
- The 19-217 SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

#### **Applications**

- Automotive: backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

#### **Device Selection Guide**

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Part No.	Material	Emitted Color	Lens Color
19-217/BHC-XL2M2TY/3T	InGaN	Blue	Water Clear

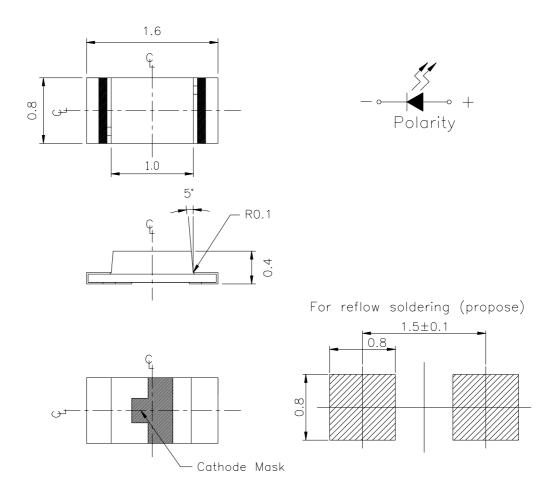


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Device No:DSE-197-B03

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## **Package Outline Dimensions**



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

Everlight Electronics Co., Ltd.

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http://www.everlight.com Prepared date: 10-Dec-2004

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Page: 2 of 10

Rev 1



#### **Absolute Maximum Ratings (Ta=25°C)**

Parameter	Symbol	Rating	Unit
Reverse Voltage	VR	5	V
Forward Current	IF	25	mA
Operating Temperature	Topr	-40 ~ +85	$^{\circ}\!\mathbb{C}$
Storage Temperature	Tstg	-40 ~ +90	$^{\circ}\!\mathbb{C}$
Soldering Temperature	Tsol	260 (for 5 second)	Ç
Electrostatic Discharge	ESD	150	V
Power Dissipation	Pd	110	mW
Peak Forward Current (Duty 1/10 @1KHz)	IFP	100	mA

## **Electro-Optical Characteristics (Ta=25°C)**

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	Iv	14.5		28.5	mcd	
Viewing Angle	2 \theta 1/2		120		deg	
Peak Wavelength	λр		468		nm	
Dominant Wavelength	λd	465		470	nm	IF=5mA
Spectrum Radiation Bandwidth	Δλ		35		nm	
Forward Voltage	VF	2.60		3.00	V	
Reverse Current	IR			50	$\mu$ A	VR=5V

#### **Notes:**

1.Tolerance of Luminous Intensity ±10%

2.Tolerance of Dominant Wavelength ±1nm

3.Tolerance of Forward Voltage ±0.05V

Rev 1 Everlight Electronics Co., Ltd. http://www.everlight.com Page: 3 of 10 Prepared date: 10-Dec-2004 Prepared by: Jessica Chang

Device No:DSE-197-B03

## Bin Range Of Dom. Wavelength

Bin	Min	Max	Unit	Condition
X	465.0	470.0	nm	IF=5mA

## **Bin Range Of Luminous Intensity**

Bin	Min	Max	Unit	Condition
L2	14.5	18.0		
M1	18.0	22.5	mcd	IF=5mA
M2	22.5	28.5		

# **Bin Rangee Of Forward Voltage**

Group	Bin	Min	Max	Unit	Condition	
Т	28	2.6	2.7			
	29	2.7	2.8	***	T	
	30	2.8	2.9	V	IF=5mA	
	31	2.9	3.0			

#### **Notes:**

1. Tolerance of Luminous Intensity ±10%

2.Tolerance of Dominant Wavelength ±1nm

3.Tolerance of Forward Voltage ±0.05V

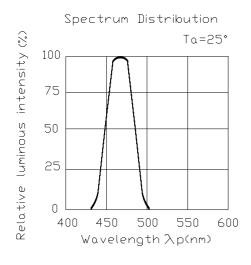
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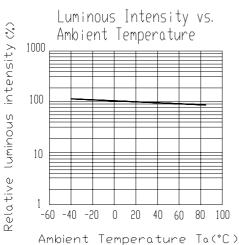
Device No:DSE-197-B03

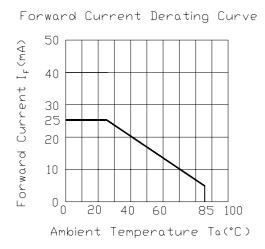
http://www.everlight.com Prepared date: 10-Dec-2004 Rev 1

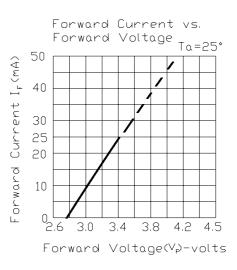
Page: 4 of 10

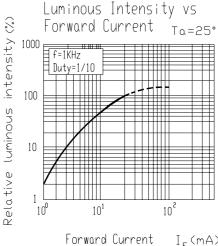
#### **Typical Electro-Optical Characteristics Curves**

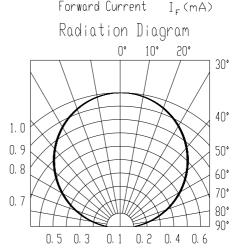












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#### Label explanation

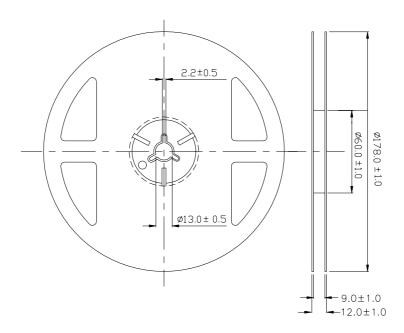
**CAT: Luminous Intensity Rank** 

**HUE: Dom. Wavelength Rank** 

**REF: Forward Voltage Rank** 

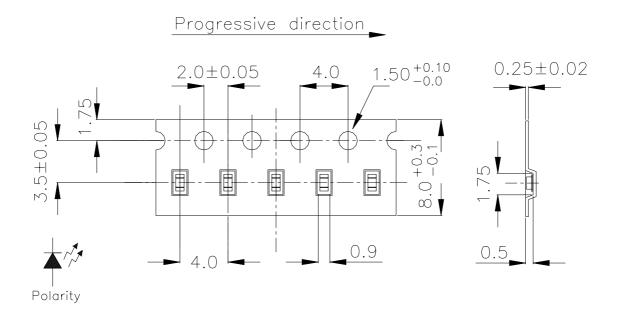


#### **Reel Dimensions**



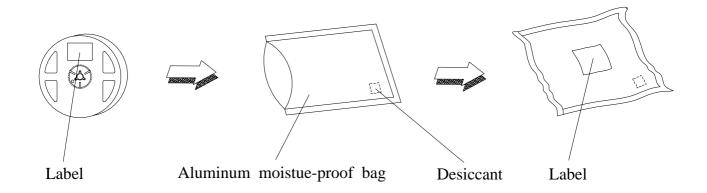
**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

### Carrier Tape Dimensions: Loaded quantity 3000 PCS per reel



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## **Moisture Resistant Packaging**



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Device No:DSE-197-B03

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Prepared date: 10-Dec-2004

Rev 1

Page: 7 of 10



## **Reliability Test Items And Conditions**

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min $\int$ 5 min $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	$H: +100^{\circ}\mathbb{C}$ 5min $\int 10 \sec$ $L: -10^{\circ}\mathbb{C}$ 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°€	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C / 85%RH	1000 Hrs.	22 PCS.	0/1

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Rev 1 Page: 8 of 10

#### **Precautions For Use**

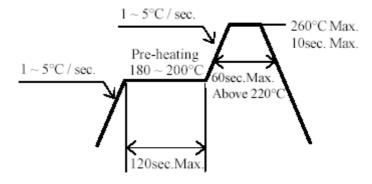
1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 The LEDs should be used within a year.
- 2.4 After opening the package, the LEDs should be kept at 30°C or less and 70%RH or less.
- 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.
- 2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment :  $60\pm5^{\circ}$ C for 24 hours.

- 3. Soldering Condition
- 3.1 Lead solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

Rev 1 Page: 9 of 10 Everlight Electronics Co., Ltd. http://www.everlight.com Prepared by: Jessica Chang Prepared date: 10-Dec-2004

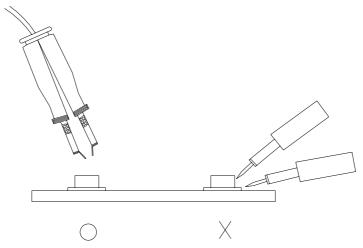


#### 4. Soldering Iron

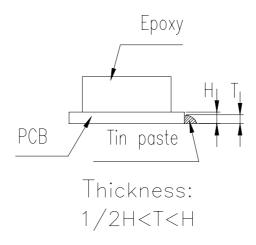
Each terminal is to go to the tip of soldering iron temperature less than  $280^{\circ}$ C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

#### 5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



# Thickness of tin paste



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